

11-22-2004

FOR: PTO-1595 (Modified)
(Rev. 03-01)
OMB No. 0651-0027 (exp.5/31/2002)
P08A/REV03

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Ja-Youn LEE, Jong-Seong LEE, Beom-Ku HAN

2. Name and address of receiving party(ies):

Name: **Samsung Electronics Co., Ltd.**

Address: **416, Maetan-dong, Yeongtong-gu**

22151 U.S. PTO
29/216960



Additional names(s) of conveying party(ies) Yes No

3. Nature of conveyance:

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City: **Suwon-si** State/Prov.: **Gyeonggi-do**

Country: **Republic of KOREA** ZIP: _____

Execution Date: **10-15-2004, 10-15-2004, 10-15-2004**

Additional name(s) & address(es) Yes No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: **10-15-04**
10-15-04, 10-15-04

Patent Application No. Filing date

B. Patent No.(s)

Additional numbers Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Jae Y. PARK**

Registration No. **PLEASE SEE ATTACHED**

Address: **55 Griffin Road South**

City: **Bloomfield** State/Prov.: **CT**

Country: **USA** ZIP: **06002**

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41):.....\$ **40.00**

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Jae Y. PARK

Name of Person Signing

Signature

November 11, 2004

Date

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ASSIGNMENT

WHEREAS I, **JA-YOUN LEE** of 6/2, 175-218, **Jingwanoe-dong, Eunpyeong-gu, Seoul, Rep. of Korea**, **JONG-SEONG LEE** of 102-1003, **Samsung Apt., Donam-dong, Sungbuk-gu, Seoul, Rep. of Korea** and **BEOM-KU HAN** of 101-2003, **Ilseonnyeong Apt., 1261, Guro-dong, Guro-gu, Seoul, Rep. of Korea** and (hereinafter referred to as "ASSIGNORS") have invented certain new and useful improvements in:

EAR PHONE

and for which We have filed an application for Letters Patent of the United States on 2004 (Serial No.);

AND WHEREAS, **SAMSUNG ELECTRONICS CO., LTD.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea, having a place of business at **416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will,

at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: October 15, 2004

Ja-Youn Lee L.S.
JA-YOUN LEE

Date: Oct. 15. 2004

Jong-seong Lee L.S.
JONG-SEONG LEE

Date: October 16, 2004

Beom-ku Han L.S.
BEOM-KU HAN